

Features

- Transient Protection for 2 Differential Line Pairs (4 lines) with Bi-directional.
- Provide Transient Protection for the Protected Differential Line Pair to IEC 61000-4-2 (ESD) ±30kV (contact/air) IEC 61000-4-4 (EFT) 60A (5/50ns) IEC 61000-4-5 (Lightning) 30A (8/20µs) Cable Discharge Event (CDE)
- JEDEC SO-8 Package.
- Specific Pin Out For Easy Board Layout.
- Fast Turn-On and Low Clamping Voltage.
- Low Operating Voltage: 2.8V.
- Low Leakage Current
- Solid-State Silicon-Avalanche and Active Circuit Triggering Technology.
- ROHS part is available
- Green part is available

Applications

- WAN/LAN Device
- 10/100/1000 Ethernet
- Switching Systems
- Computers
- Instruments
- Differential Inputs

Description

AZ3028-04P is а design which includes bi-directional surge rated clamping cells to protect two differential high speed data-line pairs in an electronic systems. The AZ3028-04P has been specifically designed to protect sensitive components which are connected to the differential line pairs from over-voltage damage and latch-up caused by Electrostatic Discharging (ESD). Electrical Fast Transients (EFT), Lightning, and Cable Discharge Event (CDE).

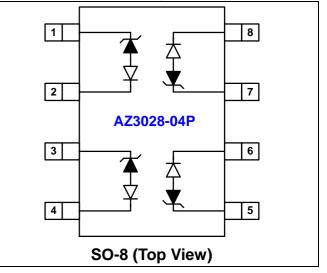
AZ3028-04P is a unique design which includes

proprietary clamping cells in a single package. During transient conditions, the proprietary clamping cells provide low clamping voltages to minimize the stress on the protected components.

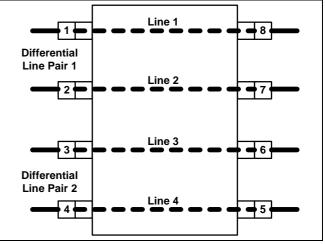
AZ3028-04P is bi-directional and may be used on lines where the signal swings above and below ground.

AZ3028-04P may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 (\pm 15kV air, \pm 8kV contact discharge).

Circuit Diagram / Pin Configuration



Circuit Board Layout Example



1



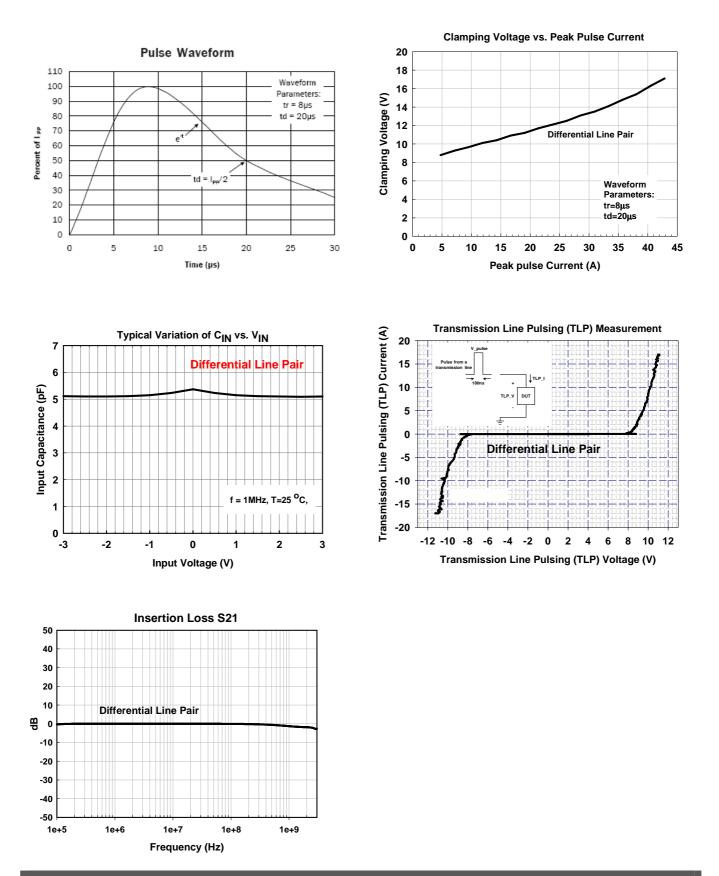
SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	RATING	UNITS	
Peak Pulse Current (tp =8/20us) for	1	30	А	
each differential line pair	IPP	30	A	
ESD per IEC 61000-4-2 (Contact /Air)	M	.20	kV	
for each differential line pair	V _{ESD}	±30	ĸv	
Lead Soldering Temperature	T _{SOL}	260 (10 sec.)	°C	
Operating Temperature	T _{OP}	-55 to +125	°C	
Storage Temperature	T _{STO}	-55 to +150	°C	

ELECTRICAL CHARACTERISTICS						
PARAMETER	SYMBOL	OL CONDITIONS		ТҮР	МАХ	UNITS
Reverse Stand-Off Voltage	V _{RWM}	T=25 °C.			2.8	V
Reverse Leakage Current	I _{Leak}	V_{RWM} = 2.8V, T=25 °C (Each Line)			1	μΑ
Reverse Breakdown Voltage	V _{BV}	I _{BV} = 1mA, T=25 °C. (Each Differential Line Pair)	3			V
Snap-Back Voltage	V _{SB}	I _{SB} = 50mA. (Each Differential Line Pair)	2.8			V
Clamping Voltage	V _{CL}	I _{PP} =5A, tp=8/20us, T=25 °C. (Each Differential Line Pair)			10	V
Clamping Voltage	V _{CL}	I _{PP} =24A, tp=8/20us, T=25 °C. (Each Differential Line Pair)			13	V
Clamping Voltage	V _{CL}	I _{PP} =30A, tp=8/20us, T=25 °C. (Each Differential Line Pair)			15	V
Channel Input Capacitance	C _{IN}	V _R = 0V, f = 1MHz, T=25 °C. (Each Differential Line Pair)		5.5		pF



Typical Characteristics





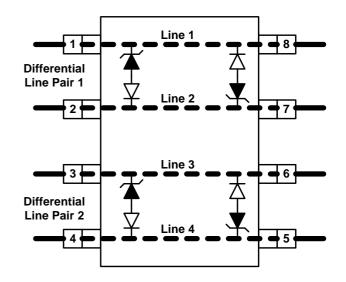
Applications Information

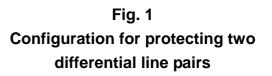
The AZ3028-04P is designed to protect four lines against System ESD/EFT/Lightning pulses by clamping them to an acceptable reference. It provides bi-directional protection.

The usage of the AZ3028-04P is shown in Fig. 1. It can be configured to protect two high speed line pairs (four lines). The first line pair is connected to Pin-1, Pin-2, Pin-8, and Pin-7, simultaneously. The second line pair is connected to Pin-3, Pin-4, Pin-6, and Pin-5, simultaneously. The traces must be connected at the bottom of AZ3028-04P.

In order to obtain enough suppression of ESD induced transient, good circuit board is critical. Thus, the following guidelines are recommended:

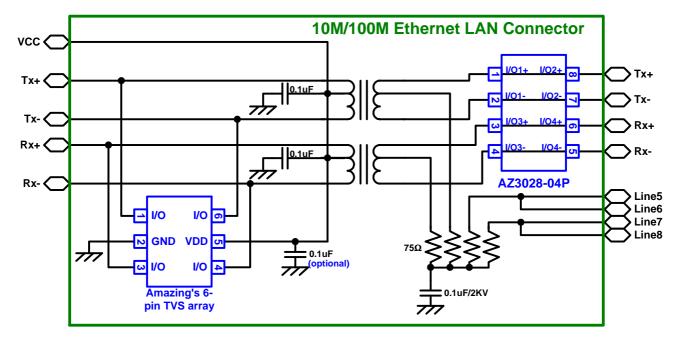
- Minimize the path length between the protected lines and the AZ3028-04P.
- Place the AZ3028-04P near the input terminals or connectors to restrict transient coupling.
- The ESD current return path to ground should be kept as short as possible.
- Use ground planes whenever possible.
- NEVER route critical signals near board edges and near the lines which the ESD transience easily injects to.



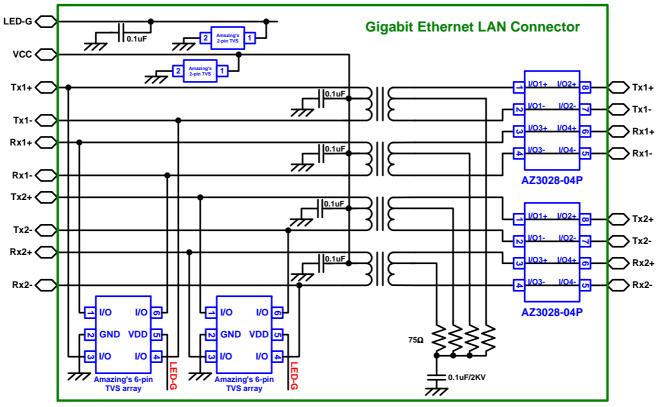




Typical Applications



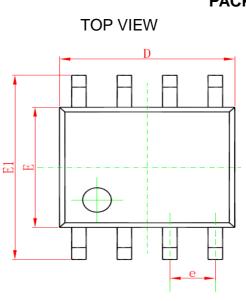
10M/100M Ethernet Protection Circuit



Gigabit Ethernet Protection Circuit



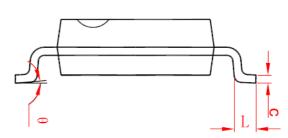
Mechanical Details



SO-8 PACKAGE DIAGRAMS

SIDE VIEW

END VIEW

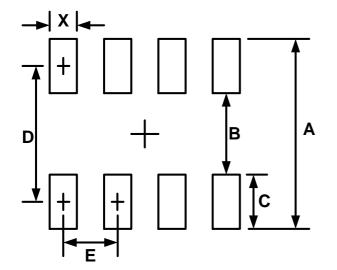


PACKAGE DIMENSIONS

Symbol	Millimeters		Inches		
Symbol	min	max	min	max	
A	1.35	1.75	0.053	0.069	
A1	0.10	0.25	0.004	0.010	
A2	1.35	1.55	0.053	0.061	
b	0.33	0.51	0.013	0.020	
С	0.17	0.26	0.007	0.010	
D	4.70	5.10	0.185	0.201	
E	3.70	4.10	0.146	0.161	
E1	5.80	6.20	0.228	0.244	
е	1.27 BSC		0.05BSC		
L	0.40	1.27	0.016	0.050	
θ	0	8	0	8	



LAND LAYOUT

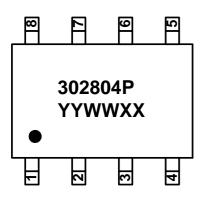


Dimensions			
Index	Millimeter	Inches	
Α	7.40	0.291	
В	3.00	0.118	
С	2.20	0.087	
D	5.20	0.205	
E	1.27	0.050	
X	0.60	0.24	

Notes:

This LAND LAYOUT is for reference purposes only. Please consult your manufacturing partners to ensure your company's PCB design guidelines are met.

MARKING CODE



302804P = Device Code YYWWXX = Date Code

Part Number	Marking Code
AZ3028-04P	302804P
(Rohs Part)	YYWWXX
AZ3028-04P	302804P
(Green Part)	YYWWXXG

Ordering Information

PN#	Material	Туре	Reel size	MOQ/interal box	MOQ/carton
AZ3028-04P.RDG	Green	T/R	13 inch	1 reel=2,500/box	5 box=12,500/carton



Revision History

Revision	Modification Description		
Revision 2008/10/17	Preliminary Release.		
Revision 2009/03/24	Formal Version Release.		
Revision 2009/12/26	Update the PACKAGE DIMENSIONS.		
	1. Update the Company Logo.		
Revision 2011/06/19	2. Add the Ordering Information.		
	3. Eliminate the index of L1 in the Mechanical Details.		